TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (π-MOSVI)

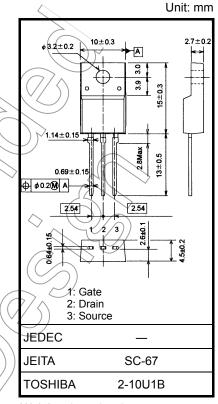
2SK3568

Switching Regulator Applications

- Low drain-source ON-resistance: $R_{DS (ON)} = 0.4 \Omega (typ.)$
- High forward transfer admittance: |Y_{fs}| = 8.5 S (typ.)
- Low leakage current: I_{DSS} = 100 μ A (V_{DS} = 500 V)
- Enhancement mode: V_{th} = 2.0 to 4.0 V (V_{DS} = 10 V, I_D = 1 mA)

Absolute Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit
Drain-source voltage		V _{DSS}	500	(Y)
Drain-gate voltage ($R_{GS} = 20 \text{ k}\Omega$)		V_{DGR}	500	$(\checkmark \checkmark)$
Gate-source voltage		V_{GSS}	±30	V
	DC (Note 1)	I _D	12	
Drain current	Pulse (t = 1 ms) (Note 1)	I _{DP}	48	
Drain power dissipati	on (Tc = 25°C)	PD	40	W
Single pulse avalanche energy (Note 2)		EAS	364	mJ
Avalanche current		I _{AR}	12	A
Repetitive avalanche energy (Note 3)		EAR	4	mJ
Channel temperature	:	(T _{ch}	150	/\°c
Storage temperature range		Tstg	-55 to 150	<i>√c</i>



Weight: 1.7 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/ Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Thermal Characteristics

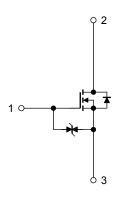
Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case	Rth (ch-c)	3.125	°C/W
Thermal resistance, channel to ambient	R _{th (ch-a)}	62.5	°C/W

Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: V_{DD} = 90 V, T_{ch} = 25°C (initial), L = 4.3 mH, I_{AR} = 12 A, R_G = 25 Ω

Note 3: Repetitive rating: pulse width limited by maximum channel temperature

This transistor is an electrostatic-sensitive device. Handle with care.

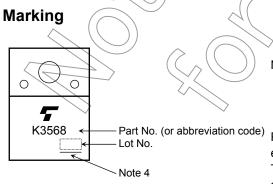


Electrical Characteristics (Ta = 25°C)

Chara	acteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cur	rent	I _{GSS}	$V_{GS} = \pm 25 \text{ V}, V_{DS} = 0 \text{ V}$	_	_	±10	μΑ
Gate-source brea	akdown voltage	V (BR) GSS	$I_G = \pm 10 \ \mu A, \ V_{DS} = 0 \ V$	±30	_	_	V
Drain cut-off curre	ent	I _{DSS}	V _{DS} = 500 V, V _{GS} = 0 V	1	_	100	μΑ
Drain-source brea	akdown voltage	V (BR) DSS	$I_D = 10 \text{ mA}, V_{GS} = 0 \text{ V}$	500		_	V
Gate threshold vo	oltage	V _{th}	V _{DS} = 10 V, I _D = 1 mA	2.0	7(4.0	V
Drain-source ON	-resistance	R _{DS} (ON)	V _{GS} = 10 V, I _D = 6 A		0.4	0.52	Ω
Forward transfer	admittance	Y _{fs}	V _{DS} = 10 V, I _D = 6 A	3.5	8.5	_	S
Input capacitance	e	C _{iss}		_	1500	_	
Reverse transfer capacitance		C _{rss}	V _{DS} = 25 V, V _{GS} = 0 V, f = 1 MHz	_	15	_	pF
Output capacitance		Coss		_	180	_	
Switching time	Rise time	t _r	10 V ID = 6 A VOUT	-	22		
	Turn-on time	t _{on}	50 Ω	_((50) —	20
	Fall time	t _f	V _{DD} ≈ 200 V		> 36	_	ns
	Turn-off time	t _{off}	Duty $\leq 1\%$, $t_W = 10 \ \mu s$		170		
Total gate charge)	Qg) —	42	_	
Gate-source charge Q _{gs}		Qgs	$V_{DD} \approx 400 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 12 \text{ A}$	_	23	_	nC
Gate-drain charge Q _{gq}		Qgd		_	19	_	

Source-Drain Ratings and Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1))) I _{DR}		_	_	12	Α
Pulse drain reverse current (Note 1)	IDRP		_	_	48	Α
Forward voltage (diode)	V _{DSF}	I _{DR} = 12-A, V _{GS} = 0 V			-1.7	V
Reverse recovery time	tri	$I_{DR} = 12 \text{ A}, V_{GS} = 0 \text{ V},$	_	1200		ns
Reverse recovery charge	Qrr	dl _{DR} /dt = 100 A/μs	_	16	_	μС

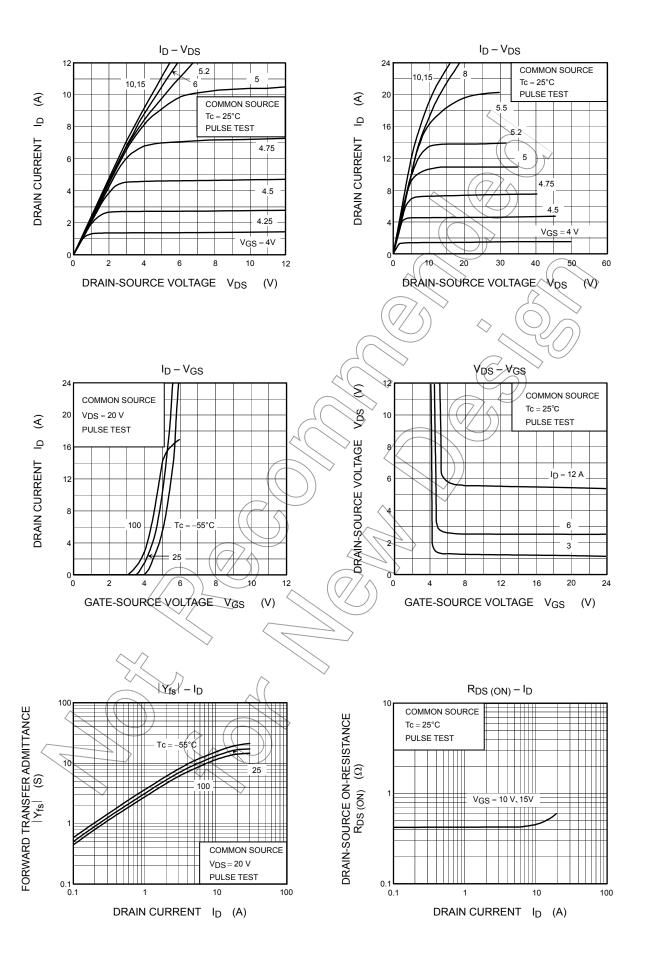


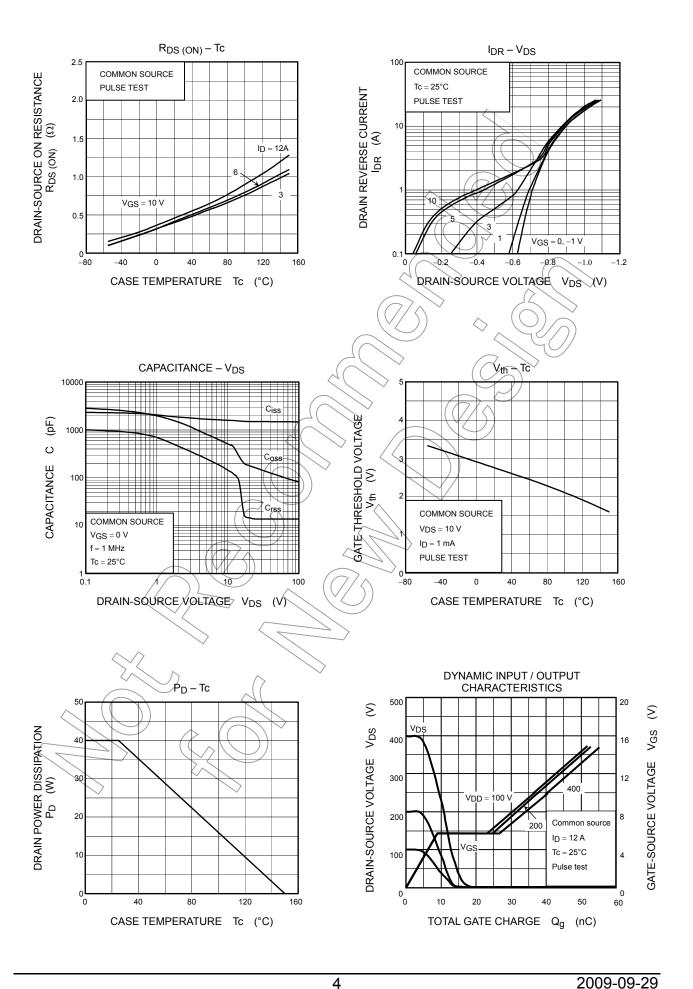
Note 4: A line under a Lot No. identifies the indication of product Labels.

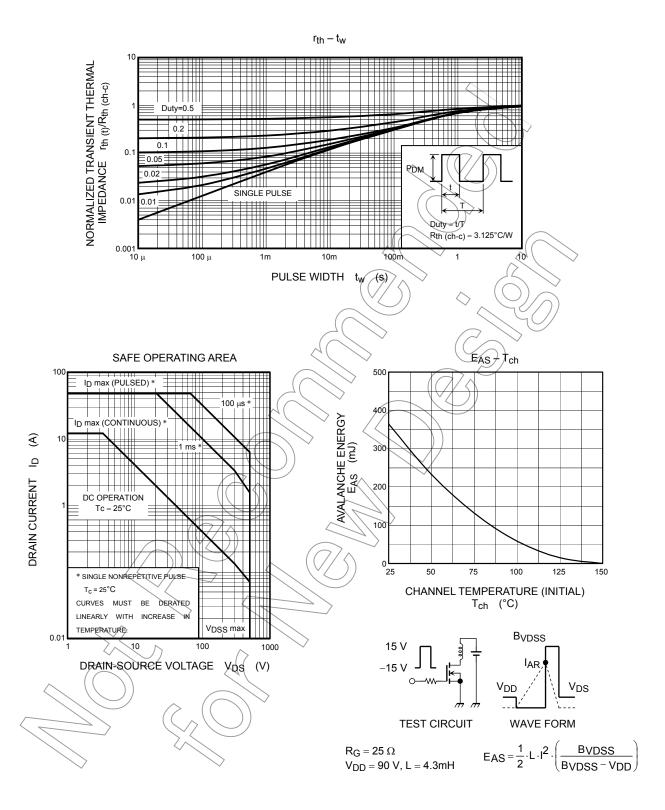
Not underlined: [[Pb]]/INCLUDES > MCV Underlined: [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

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